

## General Description

This P-Channel 1.8V specified MOSFET uses Fairchild's advanced low voltage PowerTrench process. It has been optimized for battery power management applications.

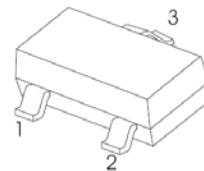
## Applications

- Battery management
- Load switch
- Battery protection

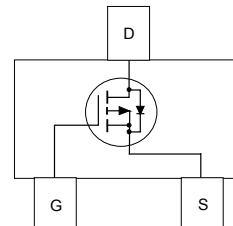
## Features

- $-2.6\text{ A}$ ,  $-12\text{ V}$ .  $R_{DS(ON)} = 40\text{ m}\Omega @ V_{GS} = -4.5\text{ V}$   
 $R_{DS(ON)} = 50\text{ m}\Omega @ V_{GS} = -2.5\text{ V}$   
 $R_{DS(ON)} = 80\text{ m}\Omega @ V_{GS} = -1.8\text{ V}$
- Fast switching speed
- High performance trench technology for extremely low  $R_{DS(ON)}$
- SuperSOT™ -3 provides low  $R_{DS(ON)}$  and 30% higher power handling capability than SOT23 in the same footprint

**SOT - 23**



1. GATE
2. SOURCE
3. DRAIN



**Absolute Maximum Ratings**  $T_A=25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Ratings	Units
$V_{DSS}$	Drain-Source Voltage	-12	V
$V_{GSS}$	Gate-Source Voltage	$\pm 8$	V
$I_D$	Drain Current – Continuous – Pulsed	-2.6 -10	A
	(Note 1a)	(Note 1b)	
$P_D$	Maximum Power Dissipation (Note 1a)	0.5	W
	(Note 1b)	0.46	
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to +150	°C

## Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)	250	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Note 1)	75	°C/W

**Electrical Characteristics**
 $T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain–Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}$ , $I_D = -250 \mu\text{A}$	-12			V
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \mu\text{A}$ , Referenced to $25^\circ\text{C}$		-3		mV/ $^\circ\text{C}$
$I_{\text{DS}S}$	Zero Gate Voltage Drain Current	$V_{\text{DS}} = -10 \text{ V}$ , $V_{\text{GS}} = 0 \text{ V}$			-1	$\mu\text{A}$
$I_{\text{GSSF}}$	Gate–Body Leakage, Forward	$V_{\text{GS}} = 8 \text{ V}$ , $V_{\text{DS}} = 0 \text{ V}$			100	nA
$I_{\text{GSSR}}$	Gate–Body Leakage, Reverse	$V_{\text{GS}} = -8 \text{ V}$ , $V_{\text{DS}} = 0 \text{ V}$			-100	nA
<b>On Characteristics</b> (Note 2)						
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}$ , $I_D = -250 \mu\text{A}$	-0.4	-0.6	-1.5	V
$\frac{\Delta V_{\text{GS}(\text{th})}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \mu\text{A}$ , Referenced to $25^\circ\text{C}$		2.5		mV/ $^\circ\text{C}$
$R_{\text{DS}(\text{on})}$	Static Drain–Source On–Resistance	$V_{\text{GS}} = -4.5 \text{ V}$ , $I_D = -2.6 \text{ A}$ $V_{\text{GS}} = -2.5 \text{ V}$ , $I_D = -2.3 \text{ A}$ $V_{\text{GS}} = -1.8 \text{ V}$ , $I_D = -1.8 \text{ A}$	30 39 54	40 50 80		$\text{m}\Omega$
$I_{\text{D}(\text{on})}$	On–State Drain Current	$V_{\text{GS}} = -4.5 \text{ V}$ , $V_{\text{DS}} = -5 \text{ V}$	-10			A
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}} = -5 \text{ V}$ , $I_D = -2.6 \text{ A}$		10		S
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}} = -6 \text{ V}$ , $V_{\text{GS}} = 0 \text{ V}$ , $f = 1.0 \text{ MHz}$		1138		pF
$C_{\text{oss}}$	Output Capacitance			454		pF
$C_{\text{rss}}$	Reverse Transfer Capacitance			302		pF
<b>Switching Characteristics</b> (Note 2)						
$t_{\text{d}(\text{on})}$	Turn–On Delay Time	$V_{\text{DD}} = -6 \text{ V}$ , $I_D = -1 \text{ A}$ , $V_{\text{GS}} = -4.5 \text{ V}$ , $R_{\text{GEN}} = 6 \Omega$		11	20	ns
$t_r$	Turn–On Rise Time			10	20	ns
$t_{\text{d}(\text{off})}$	Turn–Off Delay Time			38	61	ns
$t_f$	Turn–Off Fall Time			35	56	ns
$Q_g$	Total Gate Charge	$V_{\text{DS}} = -6 \text{ V}$ , $I_D = -2.6 \text{ A}$ , $V_{\text{GS}} = -4.5 \text{ V}$		12	17	nC
$Q_{\text{gs}}$	Gate–Source Charge			2		nC
$Q_{\text{gd}}$	Gate–Drain Charge			3		nC
<b>Drain–Source Diode Characteristics and Maximum Ratings</b>						
$I_S$	Maximum Continuous Drain–Source Diode Forward Current			-0.42		A
$V_{\text{SD}}$	Drain–Source Diode Forward Voltage	$V_{\text{GS}} = 0 \text{ V}$ , $I_S = -0.42$ (Note 2)		-0.6	-1.2	V

**Notes:**

- $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JA}$  is guaranteed by design while  $R_{\theta JC}$  is determined by the user's board design.



a)  $250^\circ\text{C}/\text{W}$  when mounted on a  $0.02 \text{ in}^2$  pad of 2 oz. copper.

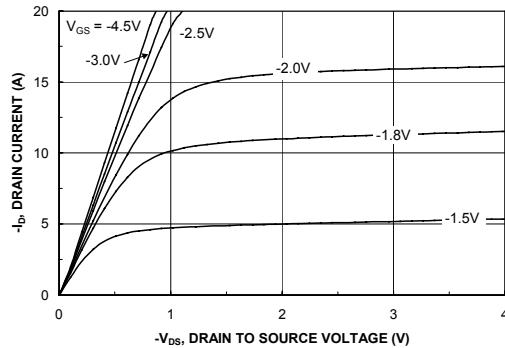


b)  $270^\circ\text{C}/\text{W}$  when mounted on a minimum pad.

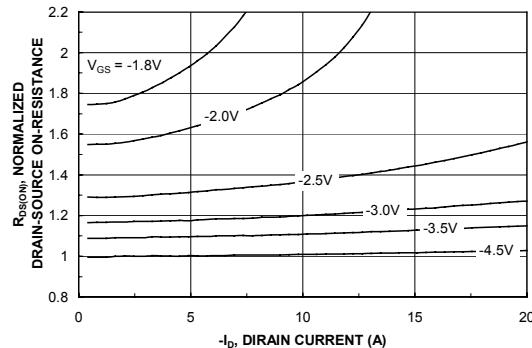
Scale 1 : 1 on letter size paper

- Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

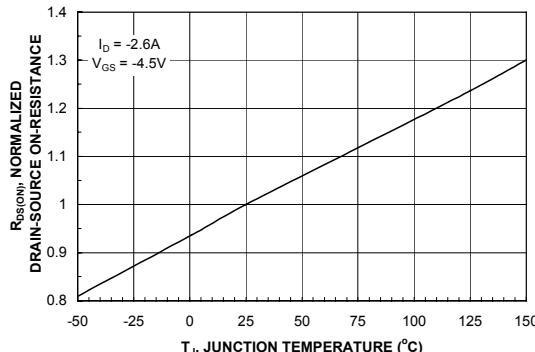
## Typical Characteristics



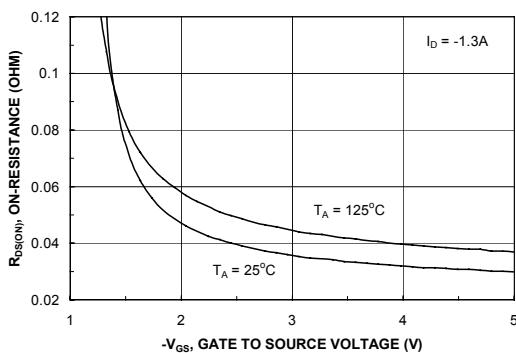
**Figure 1. On-Region Characteristics.**



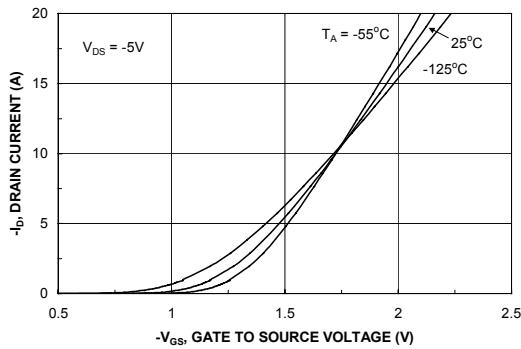
**Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.**



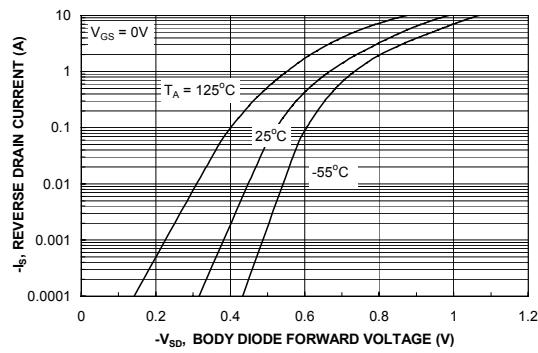
**Figure 3. On-Resistance Variation with Temperature.**



**Figure 4. On-Resistance Variation with Gate-to-Source Voltage.**

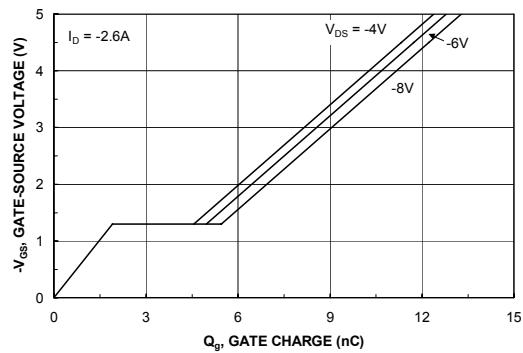


**Figure 5. Transfer Characteristics.**

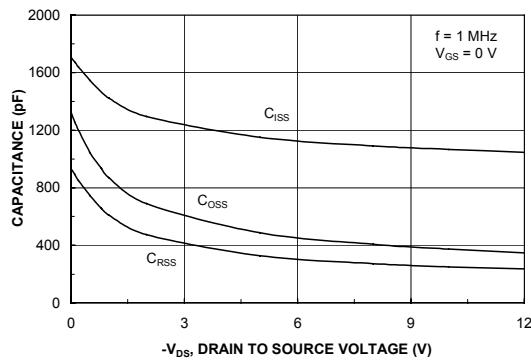


**Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.**

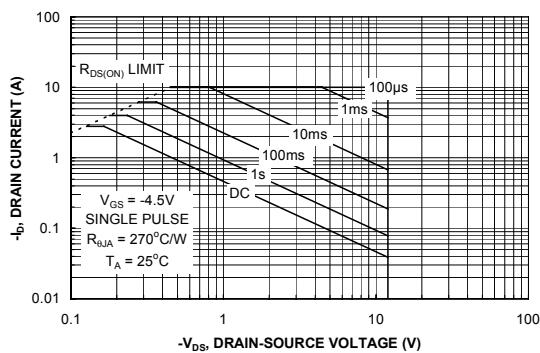
## Typical Characteristics



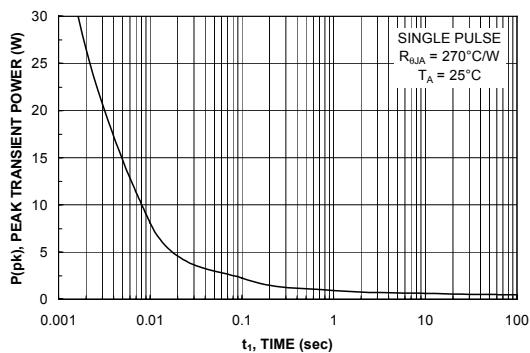
**Figure 7. Gate Charge Characteristics.**



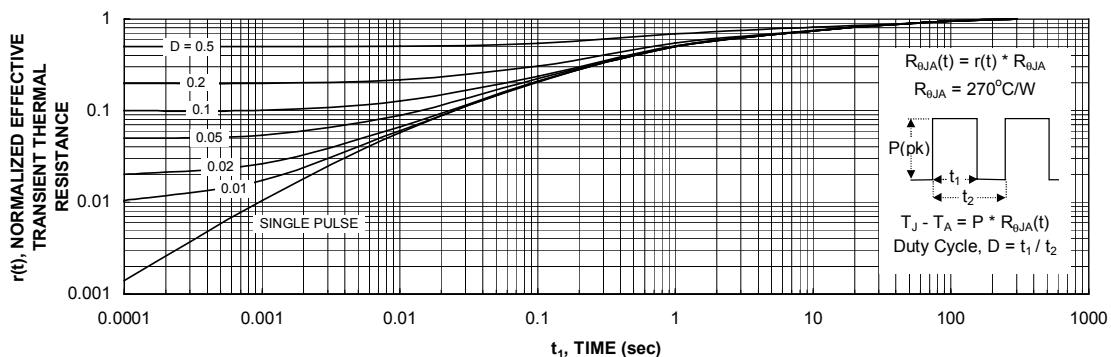
**Figure 8. Capacitance Characteristics.**



**Figure 9. Maximum Safe Operating Area.**



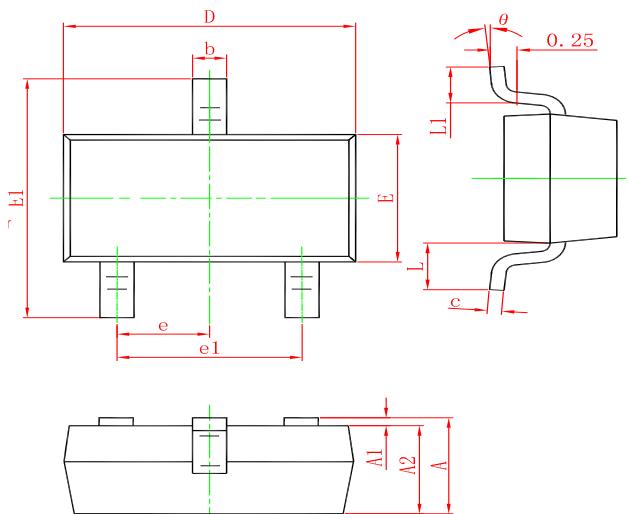
**Figure 10. Single Pulse Maximum Power Dissipation.**



**Figure 11. Transient Thermal Response Curve.**

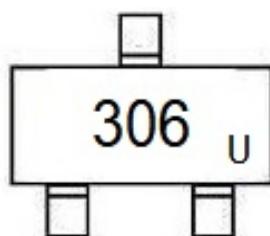
Thermal characterization performed using the conditions described in Note 1b.  
Transient thermal response will change depending on the circuit board design.

**SOT-23 PACKAGE OUTLINE DIMENSIONS**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

**Marking**



**Ordering information**

Order code	Package	Baseqty	Deliverymode
FDN306P	SOT-23	3000	Tape and reel